

Electronic Patent Application Fee Transmittal

Application Number:	10516602
Filing Date:	05-Jul-2005
Title of Invention:	Method of forming a metal pattern and a method of fabricating tft array panel by using the same
First Named Inventor/Applicant Name:	Hong-Sick Park
Filer:	Frank Chau/Scott Appelbaum
Attorney Docket Number:	8071-152T

Filed as Large Entity

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	790	790
Total in USD (\$)				790